

STARPOWER

SEMICONDUCTOR

IGBT

GD100PIT120C6SN

Molding Type Module**1200V/100A PIM in one-package**

General Description

STARPOWER IGBT Power Module provides ultra low conduction loss as well as short circuit ruggedness. They are designed for the applications such as general inverters and UPS.



Features

- Low $V_{CE(sat)}$ Trench IGBT technology
- 10 μ s short circuit capability
- $V_{CE(sat)}$ with positive temperature coefficient
- Maximum junction temperature 175 °C
- Low inductance case
- Fast & soft reverse recovery anti-parallel FWD
- Isolated copper baseplate using DBC technology

Typical Applications

- Inverter for motor drive
- AC and DC servo drive amplifier
- Uninterruptible power supply

IGBT-inverter $T_C=25^\circ\text{C}$ unless otherwise noted**Maximum Rated Values**

Symbol	Description	GD100PIT120C6SN	Units
V_{CES}	Collector-Emitter Voltage @ $T_j=25^\circ\text{C}$	1200	V
V_{GES}	Gate-Emitter Voltage @ $T_j=25^\circ\text{C}$	± 20	V
I_C	Collector Current @ $T_C=25^\circ\text{C}$	165	A
	@ $T_C=100^\circ\text{C}$	100	
I_{CM}	Pulsed Collector Current $t_p=1\text{ms}$	200	A
P_{tot}	Total Power Dissipation @ $T_j=175^\circ\text{C}$	577	W

Off Characteristics

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Units
$V_{(BR)CES}$	Collector-Emitter Breakdown Voltage	$T_j=25^\circ\text{C}$	1200			V
I_{CES}	Collector Cut-Off Current	$V_{CE}=V_{CES}, V_{GE}=0\text{V}, T_j=25^\circ\text{C}$			5.0	mA
I_{GES}	Gate-Emitter Leakage Current	$V_{GE}=V_{GES}, V_{CE}=0\text{V}, T_j=25^\circ\text{C}$			400	nA

On Characteristics

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Units
$V_{GE(th)}$	Gate-Emitter Threshold Voltage	$I_C=4.0\text{mA}, V_{CE}=V_{GE}, T_j=25^\circ\text{C}$	5.0	5.8	6.5	V
$V_{CE(sat)}$	Collector to Emitter Saturation Voltage	$I_C=100\text{A}, V_{GE}=15\text{V}, T_j=25^\circ\text{C}$		1.70	2.15	V
		$I_C=100\text{A}, V_{GE}=15\text{V}, T_j=125^\circ\text{C}$		2.00		

Switching Characteristics

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Units
$t_{d(on)}$	Turn-On Delay Time	$V_{CC}=600V, I_C=100A,$ $R_G=3.9\Omega, V_{GE}=\pm 15V,$ $T_j=25^\circ C$		265		ns
t_r	Rise Time			32		ns
$t_{d(off)}$	Turn-Off Delay Time			430		ns
t_f	Fall Time			65		ns
E_{on}	Turn-On Switching Loss			6.66		mJ
E_{off}	Turn-Off Switching Loss			8.10		mJ
$t_{d(on)}$	Turn-On Delay Time	$V_{CC}=600V, I_C=100A,$ $R_G=3.9\Omega, V_{GE}=\pm 15V,$ $T_j=125^\circ C$		300		ns
t_r	Rise Time			52		ns
$t_{d(off)}$	Turn-Off Delay Time			530		ns
t_f	Fall Time			88		ns
E_{on}	Turn-On Switching Loss			9.80		mJ
E_{off}	Turn-Off Switching Loss			12.1		mJ
C_{ies}	Input Capacitance	$V_{CE}=25V, f=1Mhz,$ $V_{GE}=0V$		7.21		nF
C_{oes}	Output Capacitance			0.38		nF
C_{res}	Reverse Transfer Capacitance			0.33		nF
Q_G	Gate Charge	$V_{CC}=600V, I_C=100A,$ $V_{GE}=-15 \dots +15V$		0.90		μC
R_{Gint}	Internal Gate Resistor			7.5		Ω
I_{SC}	SC Data	$t_p \leq 10\mu s, V_{GE}=15V,$ $T_j=125^\circ C, V_{CC}=900V,$ $V_{CEM} \leq 1200V$		400		A

Diode-inverter $T_C=25^\circ\text{C}$ unless otherwise noted**Maximum Rated Values**

Symbol	Description	GD100PIT120C6SN	Units
V_{RRM}	Repetitive Peak Reverse Voltage @ $T_j=25^\circ\text{C}$	1200	V
I_F	DC Forward Current @ $T_C=100^\circ\text{C}$	100	A
I_{FRM}	Repetitive Peak Forward Current $t_p=1\text{ms}$	200	A

Characteristics Values

Symbol	Parameter	Test Conditions		Min.	Typ.	Max.	Units
V_F	Diode Forward Vol tage	$I_F=100\text{A}$, $V_{GE}=0\text{V}$	$T_j=25^\circ\text{C}$		1.65	2.10	V
			$T_j=125^\circ\text{C}$		1.65		
Q_r	Recovered Charge	$I_F=100\text{A}$, $V_R=600\text{V}$, $R_G=3.9\Omega$, $V_{GE}=-15\text{V}$	$T_j=25^\circ\text{C}$		10.1		μC
			$T_j=125^\circ\text{C}$		21.0		
I_{RM}	Peak Reverse Recovery Current	$V_R=600\text{V}$, $R_G=3.9\Omega$, $V_{GE}=-15\text{V}$	$T_j=25^\circ\text{C}$		125		A
			$T_j=125^\circ\text{C}$		142		
E_{tec}	Reverse Recovery Energy	$V_{GE}=-15\text{V}$	$T_j=25^\circ\text{C}$		5.00		mJ
			$T_j=125^\circ\text{C}$		9.02		

Diode-rectifier $T_C=25^\circ\text{C}$ unless otherwise noted**Maximum Rated Values**

Symbol	Description	GD100PIT120C6SN	Units
V_{RRM}	Repetitive Peak Reverse Voltage @ $T_j=25^\circ\text{C}$	1600	V
I_F	DC Forward Current @ $T_C=80^\circ\text{C}$	100	A
I_{RMSM}	Maximum RMS Current At Rectifier Output @ $T_C=80^\circ\text{C}$	150	A
I_{FSM}	Surge Forward Current $V_R=0\text{V}, t_p=10\text{ms}, T_j=45^\circ\text{C}$	1100	A
I^2t	I^2t -value, $V_R=0\text{V}, t_p=10\text{ms}, T_j=45^\circ\text{C}$	6050	A^2s

Characteristics Values

Symbol	Parameter	Test Conditions		Min.	Typ.	Max.	Units
V_F	Diode Forward Vol tage	$I_F=100\text{A}$	$T_j=150^\circ\text{C}$		1.10		V
I_R	Reverse Current	$T_j=150^\circ\text{C}, V_R=1600\text{V}$				2.0	mA

IGBT-brake-chopper $T_C=25^\circ\text{C}$ unless otherwise noted**Maximum Rated Values**

Symbol	Description	GD100PIT120C6SN	Units
V_{CES}	Collector-Emitter Voltage @ $T_j=25^\circ\text{C}$	1200	V
V_{GES}	Gate-Emitter Voltage @ $T_j=25^\circ\text{C}$	± 30	V
I_C	Collector Current @ $T_C=25^\circ\text{C}$	85	A
	@ $T_C=100^\circ\text{C}$	50	
I_{CM}	Pulsed Collector Current $t_p=1\text{ms}$	100	A
P_{tot}	Total Power Dissipation @ $T_j=175^\circ\text{C}$	323	W

Off Characteristics

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Units
$V_{(BR)CES}$	Collector-Emitter Breakdown Voltage	$T_j=25^\circ\text{C}$	1200			V
I_{CES}	Collector Cut-Off Current	$V_{CE}=V_{CES}, V_{GE}=0\text{V}, T_j=25^\circ\text{C}$			5.0	mA
I_{GES}	Gate-Emitter Leakage Current	$V_{GE}=V_{GES}, V_{CE}=0\text{V}, T_j=25^\circ\text{C}$			400	nA

On Characteristics

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Units
$V_{GE(th)}$	Gate-Emitter Threshold Voltage	$I_C=2.4\text{mA}, V_{CE}=V_{GE}, T_j=25^\circ\text{C}$	5.0	6.1	7.5	V
$V_{CE(sat)}$	Collector to Emitter Saturation Voltage	$I_C=50\text{A}, V_{GE}=15\text{V}, T_j=25^\circ\text{C}$		1.90	2.35	V
		$I_C=50\text{A}, V_{GE}=15\text{V}, T_j=125^\circ\text{C}$		2.30		

Switching Characteristics

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Units
$t_{d(on)}$	Turn-On Delay Time	$V_{CC}=600V, I_C=50A,$ $R_G=15\Omega, V_{GE}=\pm 15V,$ $T_j=25^\circ C$		148		ns
t_r	Rise Time			83		ns
$t_{d(off)}$	Turn-Off Delay Time			245		ns
t_f	Fall Time			251		ns
E_{on}	Turn-On Switching Loss			5.51		mJ
E_{off}	Turn-Off Switching Loss			2.70		mJ
$t_{d(on)}$	Turn-On Delay Time	$V_{CC}=600V, I_C=50A,$ $R_G=15\Omega, V_{GE}=\pm 15V,$ $T_j=125^\circ C$		263		ns
t_r	Rise Time			84		ns
$t_{d(off)}$	Turn-Off Delay Time			256		ns
t_f	Fall Time			292		ns
E_{on}	Turn-On Switching Loss			6.63		mJ
E_{off}	Turn-Off Switching Loss			3.25		mJ
C_{ies}	Input Capacitance	$V_{CE}=30V, f=1Mhz,$ $V_{GE}=0V$		6.24		nF
C_{oes}	Output Capacitance			0.23		nF
C_{res}	Reverse Transfer Capacitance			0.15		nF
Q_G	Gate Charge	$V_{CC}=600V, I_C=50A,$ $V_{GE}=0-15V$		290		nC
I_{SC}	SC Data	$t_p \leq 10\mu s, V_{GE}=15V,$ $T_j=125^\circ C, V_{CC}=900V,$ $V_{CEM} \leq 1200V$		500		A

Diode-brake-chopper $T_C=25^\circ C$ unless otherwise noted**Maximum Rated Values**

Symbol	Description	GD100PIT120C6SN	Units
V_{RRM}	Repetitive Peak Reverse Voltage @ $T_j=25^\circ C$	1200	V
I_F	DC Forward Current @ $T_C=100^\circ C$	30	A
I_{FRM}	Repetitive Peak Forward Current $t_p=1ms$	60	A

Characteristics Values

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Units	
V_F	Diode Forward Voltage	$I_F=30A, V_{GE}=0V$	$T_j=25^\circ C$		1.90	2.30	V
			$T_j=125^\circ C$		1.80		
Q_r	Recovered Charge	$I_F=30A,$ $V_R=600V,$ $R_G=15\Omega,$ $V_{GE}=-15V$	$T_j=25^\circ C$		2.6		μC
			$T_j=125^\circ C$		4.2		
I_{RM}	Peak Reverse Recovery Current	$V_R=600V,$ $R_G=15\Omega,$ $V_{GE}=-15V$	$T_j=25^\circ C$		20		A
			$T_j=125^\circ C$		23		
E_{rec}	Reverse Recovery Energy	$V_{GE}=-15V$	$T_j=25^\circ C$		1.31		mJ
			$T_j=125^\circ C$		2.08		

Electrical Characteristics of NTC $T_C=25^\circ\text{C}$ unless otherwise noted

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Units
R_{25}	Rated Resistance			5.0		$k\Omega$
$\Delta R/R$	Deviation of R_{100}	$T_C=100^\circ\text{C}, R_{100}=493.3\Omega$	-5		5	%
P_{25}	Power Dissipation				20.0	mW
$B_{25/50}$	B-value	$R_2=R_{25}\exp[B_{25/50}(1/T_2-1/(298.15K))]$		3375		K

IGBT Module

Symbol	Parameter	Min.	Typ.	Max.	Units
V_{ISO}	Isolation Voltage RMS, $f=50\text{Hz}, t=1\text{min}$	2500			V
L_{CE}	Stray Inductance		40		nH
$R_{CC'+EE'}$ $R_{AA'+CC'}$	Module Lead Resistance, Terminal to Chip @ $T_C=25^\circ\text{C}$		4.00 3.00		$m\Omega$
$R_{\theta JC}$	Junction-to-Case (per IGBT-inverter) Junction-to-Case (per Diode-inverter) Junction-to-Case (per Diode-rectifier) Junction-to-Case (per IGBT-brake-chopper) Junction-to-Case (per Diode-brake-chopper)			0.260 0.482 0.543 0.464 1.045	K/W
$R_{\theta CS}$	Case-to-Sink (Conductive grease applied)		0.009		K/W
T_{jmax}	Maximum Junction Temperature (inverter, brake) Maximum Junction Temperature (rectifier)			175 150	$^\circ\text{C}$
T_{jop}	Operating Junction Temperature	-40		150	$^\circ\text{C}$
T_{STG}	Storage Temperature Range	-40		125	$^\circ\text{C}$
Mounting Torque	Mounting Screw: M5	3.0		6.0	N.m
G	Weight of Module		300		g

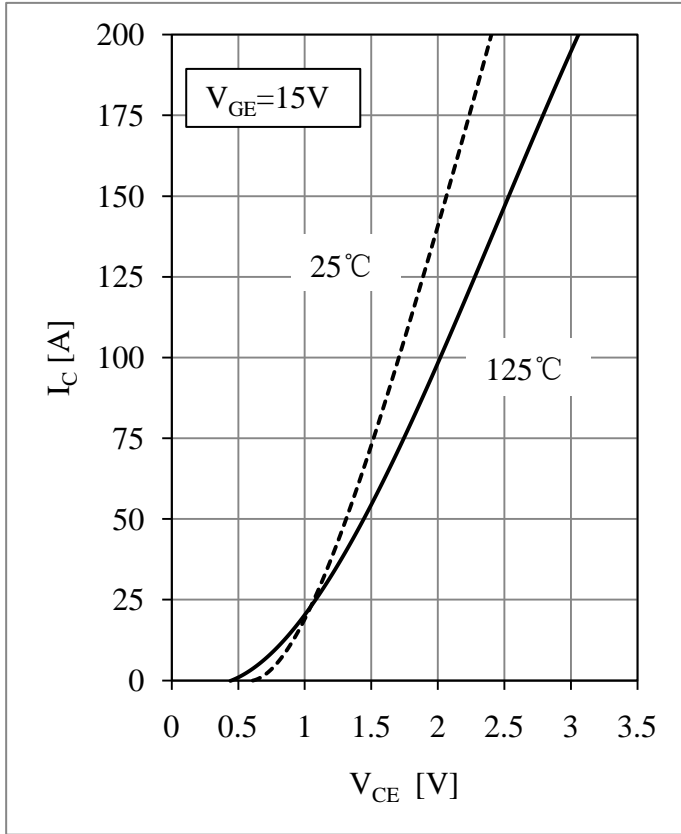


Fig 1. IGBT-inverter Output Characteristics

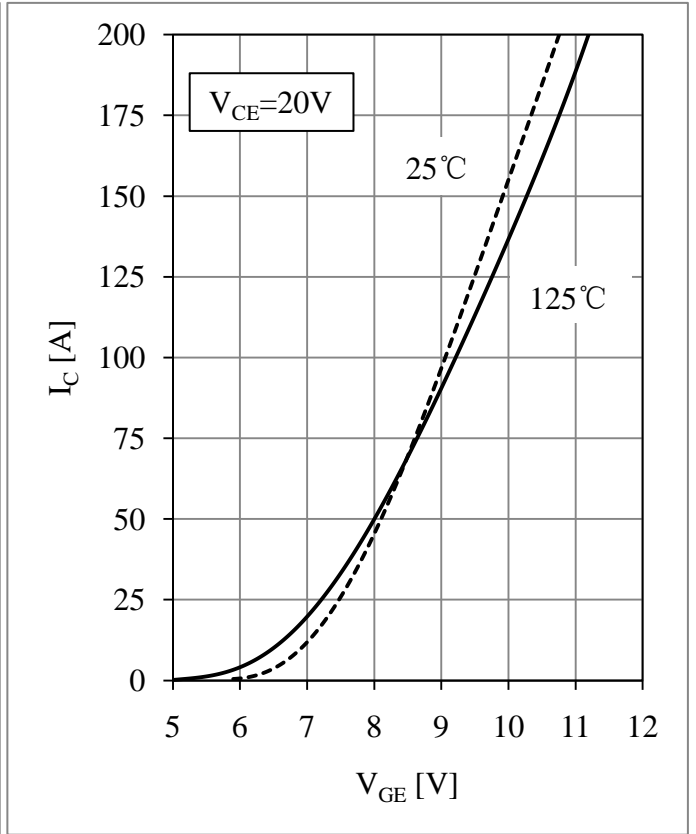


Fig 2. IGBT-inverter Transfer Characteristics

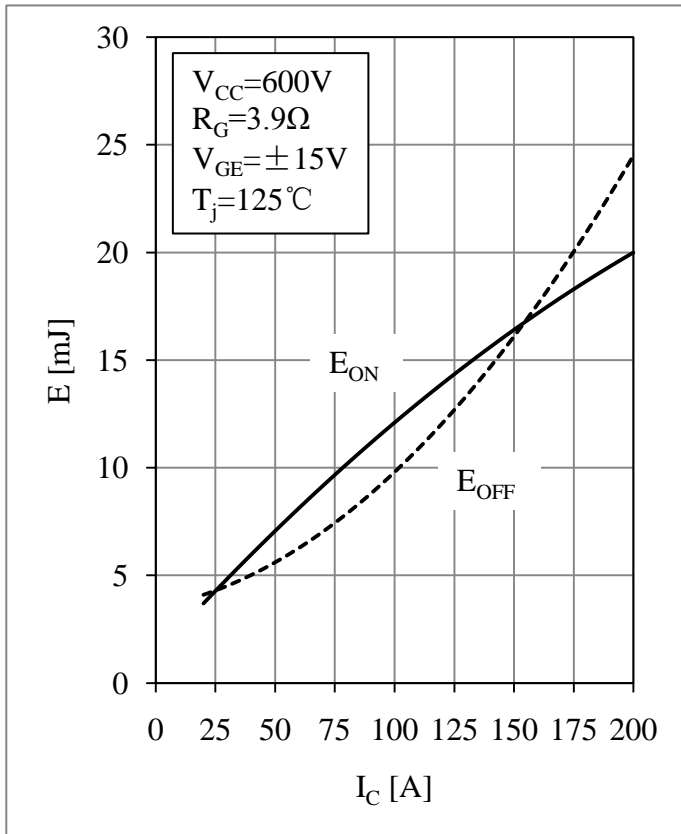


Fig 3. IGBT-inverter Switching Loss vs. I_C

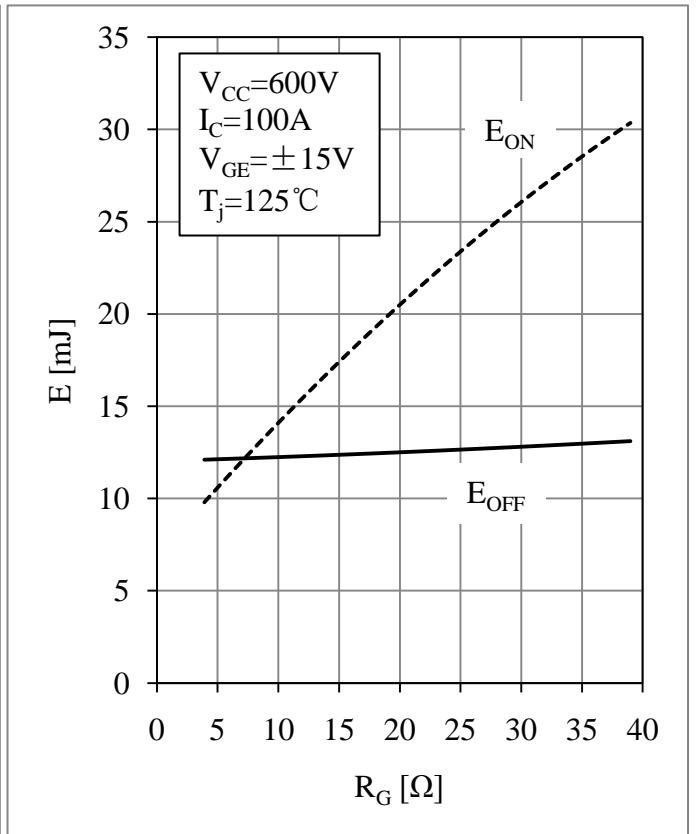


Fig 4. IGBT-inverter Switching Loss vs. R_G

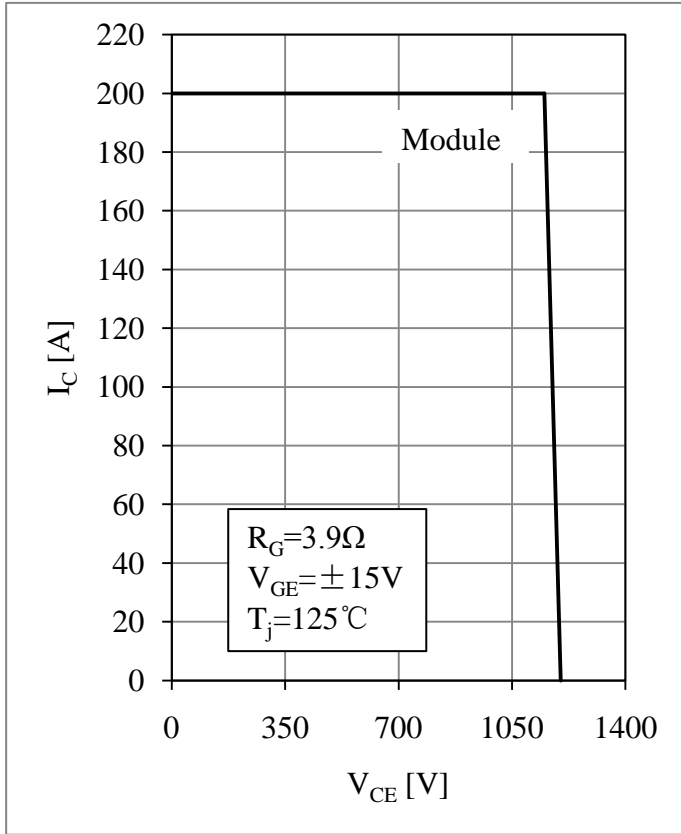


Fig 5. IGBT-inverter RBSOA

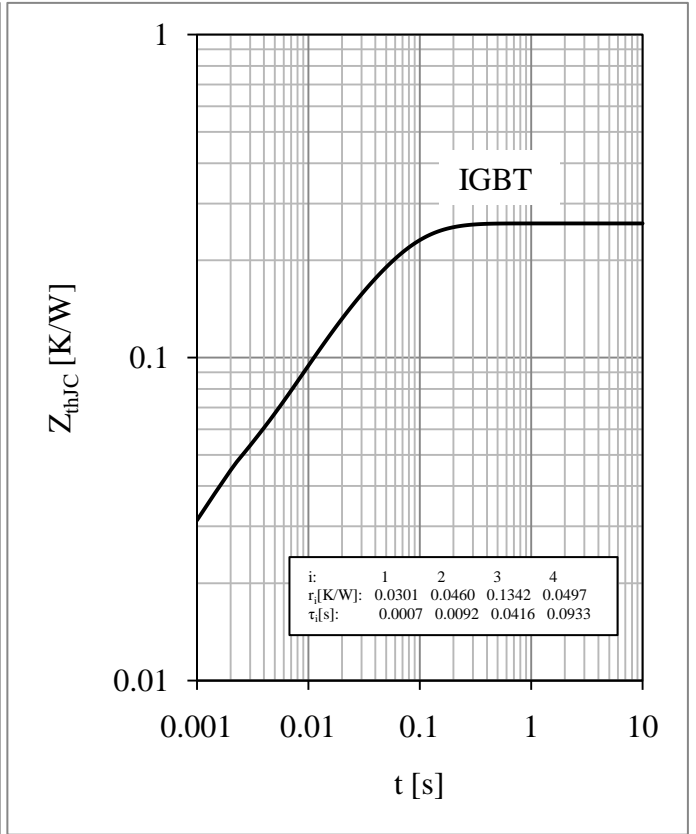


Fig 6. IGBT-inverter Transient Thermal Impedance

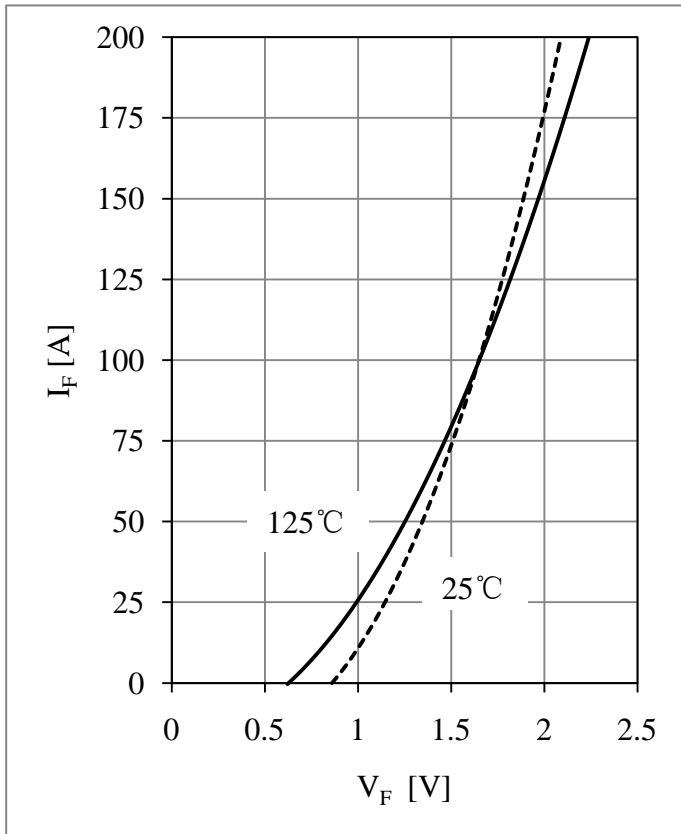


Fig 7. Diode-inverter Forward Characteristics

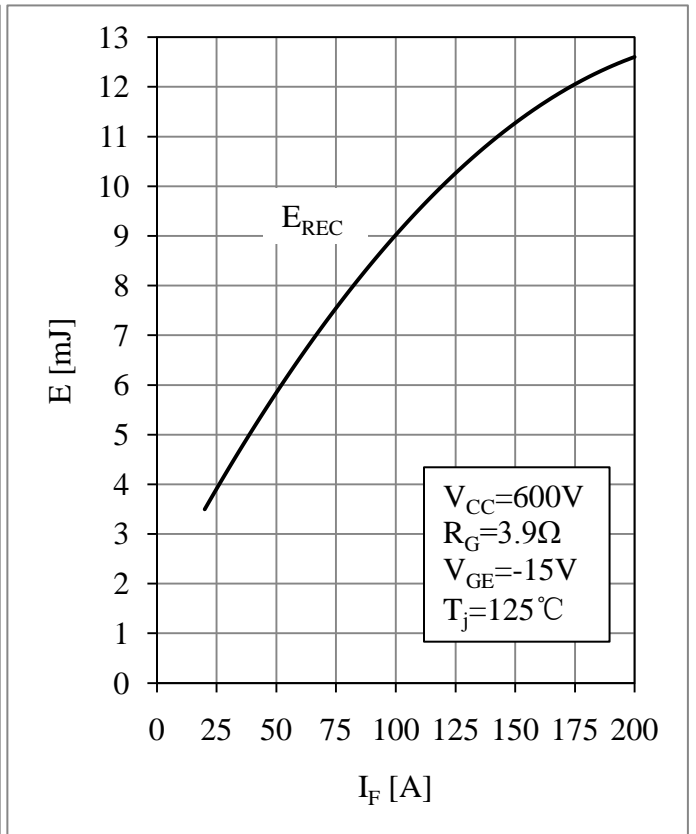


Fig 8. Diode-inverter Switching Loss vs. I_F

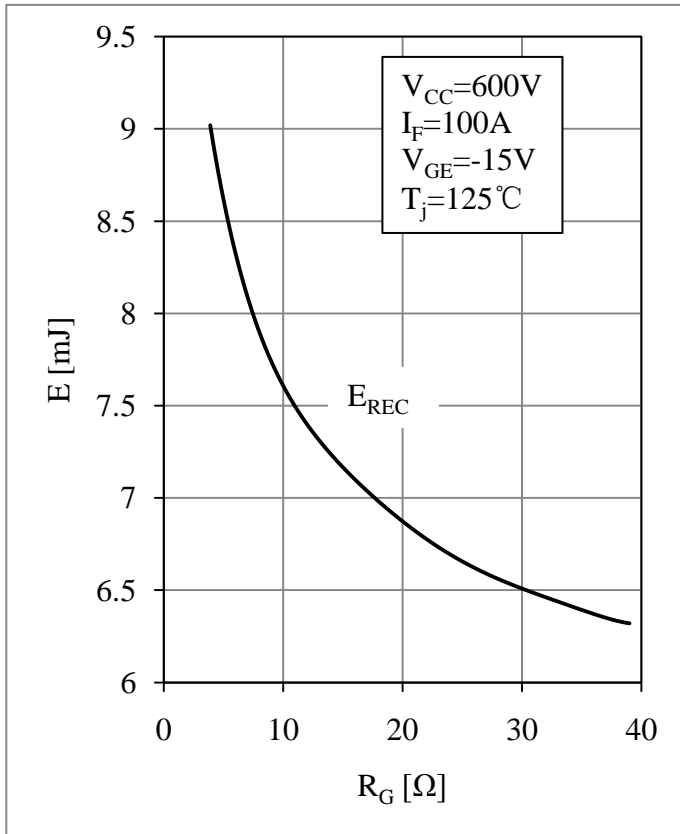


Fig 9. Diode-inverter Switching Loss vs. R_G

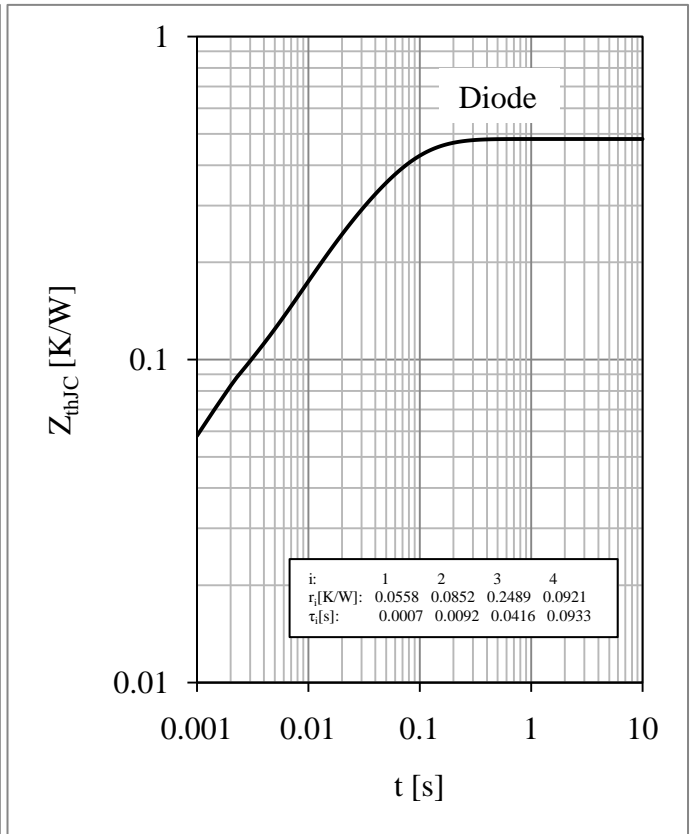


Fig 10. Diode-inverter Transient Thermal Impedance

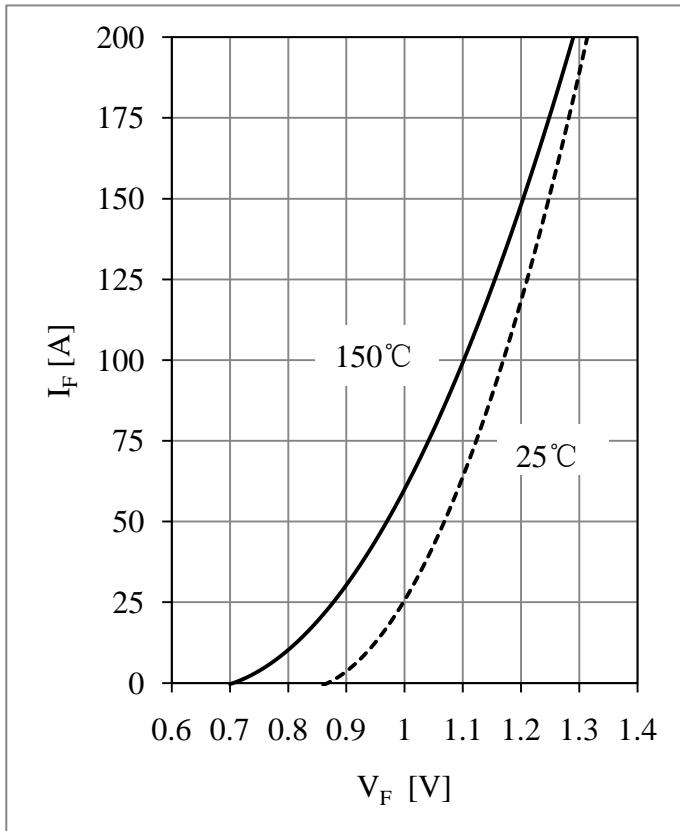


Fig 11. Diode-rectifier Forward Characteristics

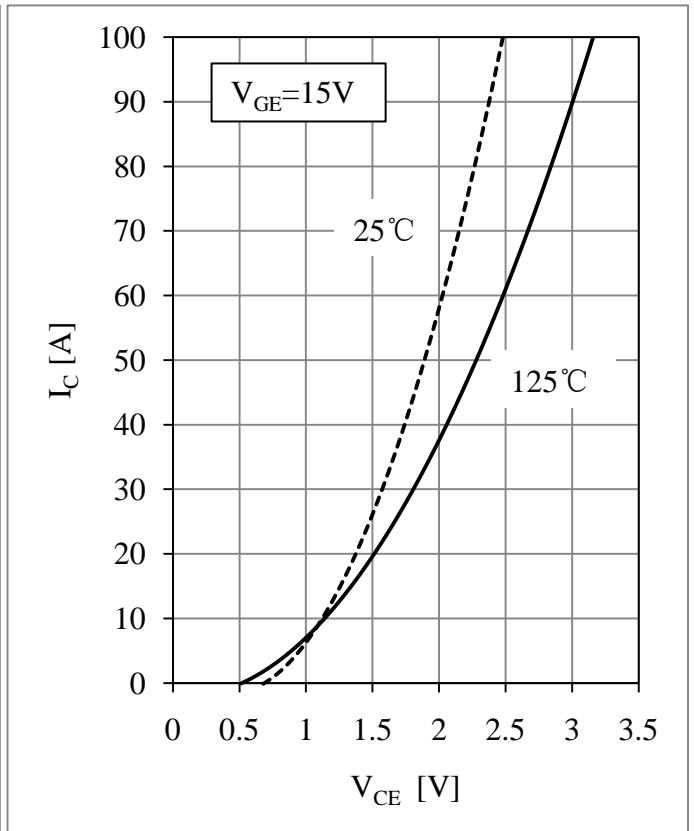


Fig 12. IGBT-brake-chopper Output Characteristics

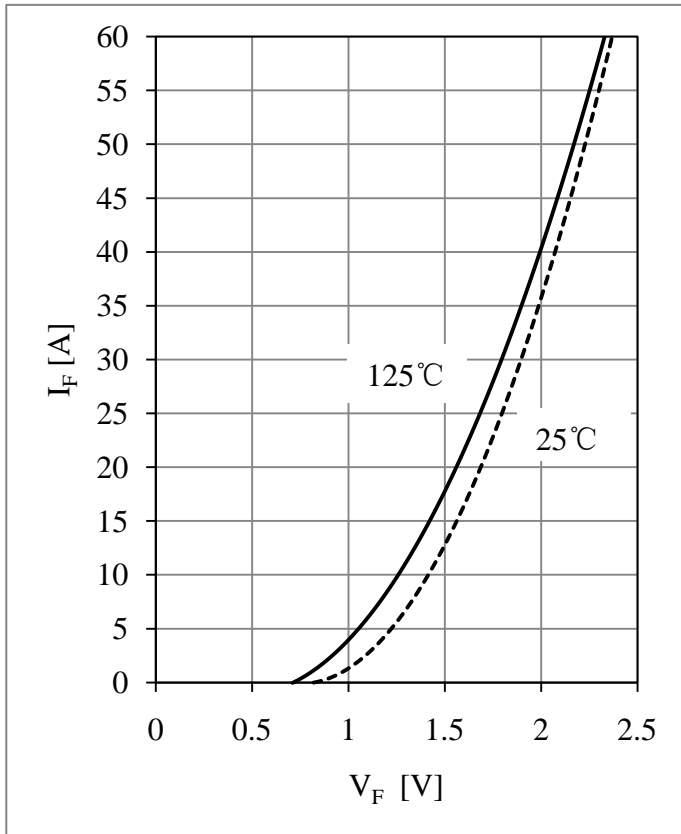


Fig 13. Diode-brake-chopper Forward Characteristics

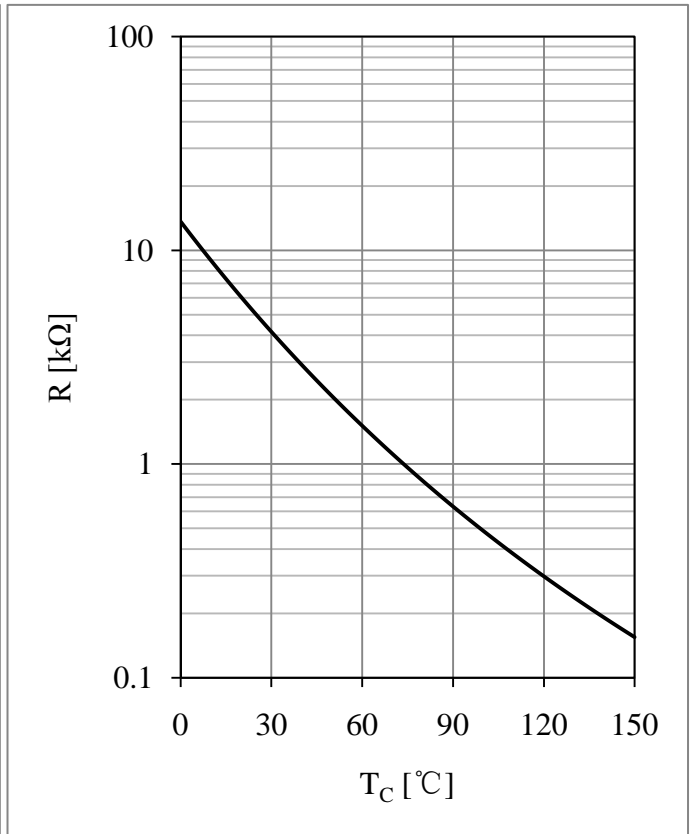
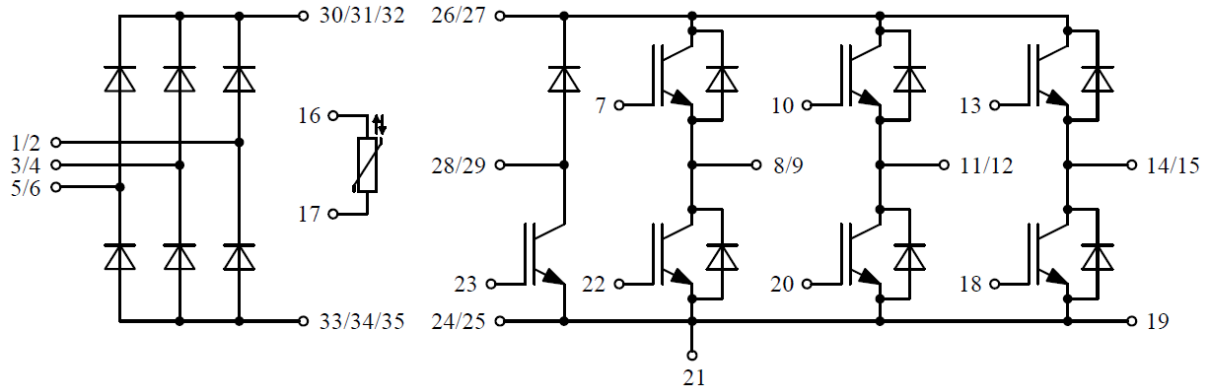


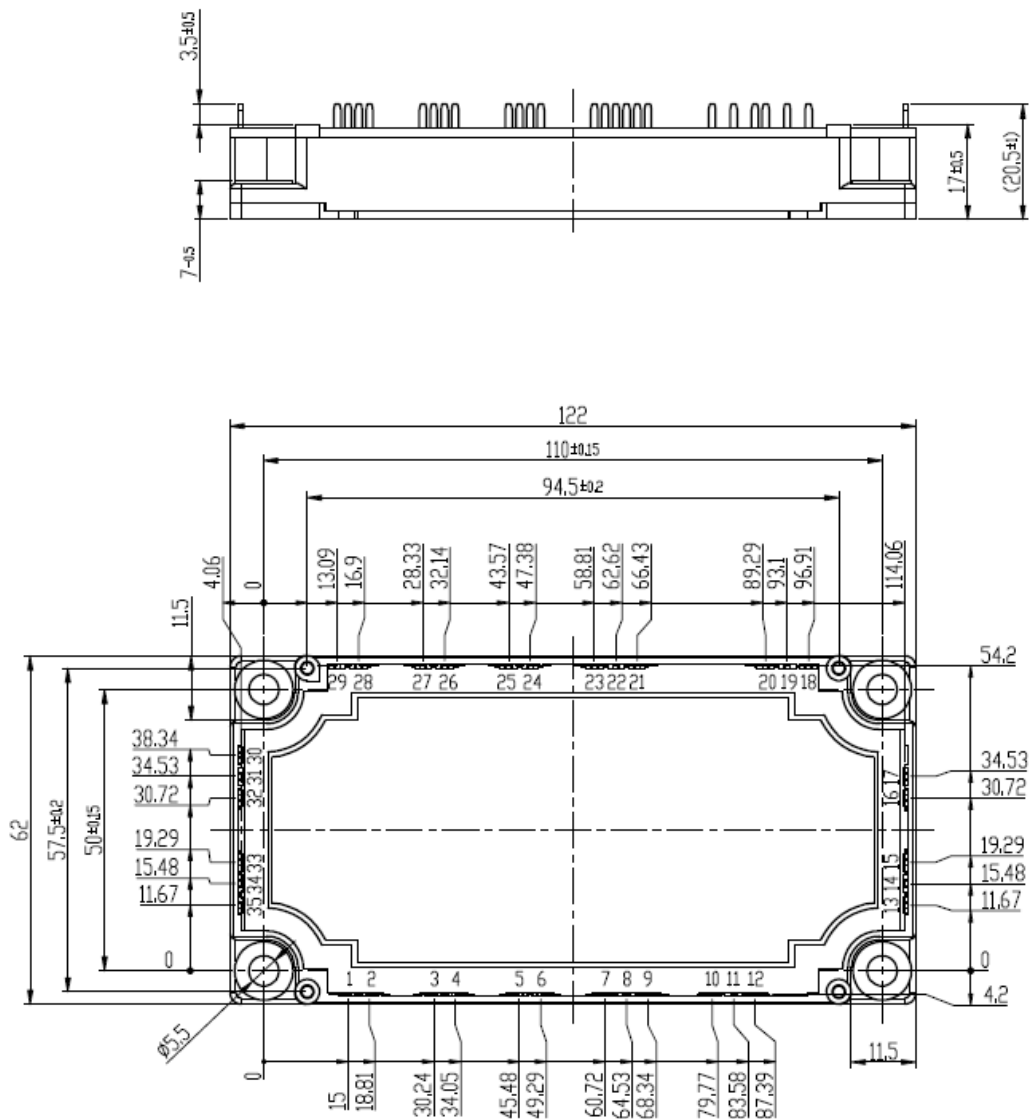
Fig 14. NTC Temperature Characteristic

Equivalent Circuit Schematic



Package Dimensions

Dimensions in Millimeters



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